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INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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Sheet 1 of

Application Number	10/047,978
Filing Date	1/13/02
First Named Inventor	Steven Teig
Group Art Unit	2825
Examiner Name	Lit with mole
Attorney Docket Number	SPLX.P0089

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Sheet 2 of

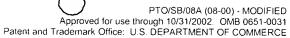
Application Number	10/047,978
Filing Date	1/13/02
First Named Inventor	Steven Teig
Group Art Unit	2825
Examiner Name	2HU WHITMORE
Attorney Docket Number	SPLX.P0089

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Application Number 10/047,978 Substitute for form 1449A/PTO Filing Date 1/13/02 INFORMATION DISCLOSURE First Named Inventor Steven Teig TATEMENT BY APPLICANT Group Art Unit 2825 (use as many sheets as necessary) **Examiner Name** 3 3 Sheet of Attorney Docket Number SPLX.P0089

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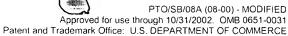
Application Number 10/047,978 Substitute for form 1449A/PTO Filing Date 1/13/02 FORMATION DISCLOSURE First Named Inventor Steven Teig STATEMENT BY APPLICANT 2825 Group Art Unit (use as many sheets as necessary) **Examiner Name** Sheet 4 Attorney Docket Number SPLX.P0089

		OTHER PRIOR ART – NON PATENT LITERATURE DOCUMENTS	
Examiner* Initials	Cite No.1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ⁶
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xpe a plus sign (+) inside this box **Application Number** 10/047,978 Substitute for form 1449A/PTO Filing Date 1/13/02 INFORMATION DISCLOSURE First Named Inventor Steven Teig STATEMENT BY APPLICANT Group Art Unit 2825 (use as many sheets as necessary) **Examiner Name** Sheet 5 of 5 Attorney Docket Number

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